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The HFA1112 is a closed loop Buffer featuring user programmable gain and ultra high speed performance. Manufactured on Intersil's proprietary complementary bipolar UHF-1 process, these devices offer a wide -3dB bandwidth of 850 MHz , very fast slew rate, excellent gain flatness, low distortion and high output current.

A unique feature of the pinout allows the user to select a voltage gain of $+1,-1$, or +2 , without the use of any external components. Gain selection is accomplished via connections to the inputs, as described in the "Application Information" section. The result is a more flexible product, fewer part types in inventory, and more efficient use of board space.

Compatibility with existing op amp pinouts provides flexibility to upgrade low gain amplifiers, while decreasing component count. Unlike most buffers, the standard pinout provides an upgrade path should a higher closed loop gain be needed at a future date.

This amplifier is available with programmable output limiting as the HFA1113. For applications requiring a standard buffer pinout, please refer to the HFA1110 data sheet.

HFA1112 (PDIP, SOIC)
TOP VIEW


## Pin Descriptions

| NAME | PIN NUMBER | DESCRIPTION |
| :---: | :---: | :--- |
| NC | $1,5,8$ | No Connection |
| -IN | 2 | Inverting Input |
| + IN | 3 | Non-Inverting Input |
| V- | 4 | Negative Supply |
| OUT | 6 | Output |
| V+ | 7 | Positive Supply |

## Features

- User Programmable for Closed-Loop Gains of $+1,-1$ or +2 without Use of External Resistors
- Wide -3dB Bandwidth 850 MHz
- Very Fast Slew Rate. . . . . . . . . . . . . . . . . . . . . . . 2400V/ $\mu \mathrm{s}$
- Fast Settling Time (0.1\%). . . . . . . . . . . . . . . . . . . . . . 11ns
- High Output Current . . . . . . . . . . . . . . . . . . . . . . . . . . 60mA
- Excellent Gain Accuracy . . . . . . . . . . . . . . . . . . . 0.99V/V
- Overdrive Recovery . . . . . . . . . . . . . . . . . . . . . . . . <10ns
- Standard Operational Amplifier Pinout
- Pb-Free Plus Anneal Available (RoHS Compliant)


## Applications

- RF/IF Processors
- Driving Flash A/D Converters
- High-Speed Communications
- Impedance Transformation
- Line Driving
- Video Switching and Routing
- Radar Systems
- Medical Imaging Systems
- Related Literature
- AN9507, Video Cable Drivers Save Board Space


## Related Literature

- Technical Brief TB363 "Guidelines for Handling and Processing Moisture Sensitive Surface Mount Devices (SMDs)"


## Ordering Information

| PART NUMBER <br> (BRAND) | TEMP. <br> RANGE $\left({ }^{\circ} \mathrm{C}\right)$ | PACKAGE | PKG. <br> DWG. $\#$ |
| :--- | :---: | :--- | :--- |
| HFA1112IP | -40 to 85 | 8 Ld PDIP | E8.3 |
| HFA1112IB <br> $(1112 I B)$ | -40 to 85 | 8 Ld SOIC | M8.15 |
| HFA1112IB96 <br> (1112IB) | 8 Ld SOIC Tape and Reel | M8.15 |  |
| HFA1112IBZ <br> (1112IBZ) (Note) | -40 to 85 | 8 Ld SOIC <br> (Pb-free) | M8.15 |
| HFA1112IBZ96 <br> (1112IBZ) (Note) | 8 Ld SOIC Tape and Reel <br> (Pb-free) | M8.15 |  |
| HFA11XXEVAL | High Speed Op Amp DIP Evaluation Board |  |  |

NOTE: Intersil Pb-free plus anneal products employ special Pb -free material sets; molding compounds/die attach materials and $100 \%$ matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb -free soldering operations. Intersil Pb -free products are MSL classified at Pb -free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

Absolute Maximum Ratings
Voltage Between V+ and V- . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 12 V
Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . VSUPPLY
Output Current. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 60mA

## Operating Conditions

Temperature Range
$-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

## Thermal Information

Thermal Resistance (Typical, Note 1) $\quad \theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right) \quad \theta_{\mathrm{JC}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$

| PDIP Package . . . . . . . . . . . . . . . . . . . | 125 | 170 |
| :--- | :--- | :--- |
| NOIC Package . . . . . . . . . . . . . | N/A |  |

Maximum Junction Temperature (Plastic Package) . . . . . . . . $150^{\circ} \mathrm{C}$
Maximum Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Maximum Lead Temperature (Soldering 10s) . . . . . . . . . . . . $300^{\circ} \mathrm{C}$ (SOIC - Lead Tips Only)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
NOTE:

1. $\theta_{J A}$ is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

Electrical Specifications $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, A_{V}=+1, R_{L}=100 \Omega$, Unless Otherwise Specified

| PARAMETER | TEST CONDITIONS | TEMP ( ${ }^{\circ} \mathrm{C}$ ) | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Output Offset Voltage |  | 25 | - | 8 | 25 | mV |
|  |  | Full | - | - | 35 | mV |
| Output Offset Voltage Drift |  | Full | - | 10 | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| PSRR |  | 25 | 39 | 45 | - | dB |
|  |  | Full | 35 | - | - | dB |
| Input Noise Voltage (Note 3) | 100kHz | 25 | - | 9 | - | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Non-Inverting Input Noise Current (Note 3) | 100 kHz | 25 | - | 37 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Non-Inverting Input Bias Current |  | 25 | - | 25 | 40 | $\mu \mathrm{A}$ |
|  |  | Full | - | - | 65 | $\mu \mathrm{A}$ |
| Non-Inverting Input Resistance |  | 25 | 25 | 50 | - | $\mathrm{k} \Omega$ |
| Inverting Input Resistance (Note 2) |  | 25 | 240 | 300 | 360 | $\Omega$ |
| Input Capacitance |  | 25 | - | 2 | - | pF |
| Input Common Mode Range |  | Full | $\pm 2.5$ | $\pm 2.8$ | - | V |
| TRANSFER CHARACTERISTICS |  |  |  |  |  |  |
| Gain | $A_{V}=+1, V_{I N}=+2 V$ | 25 | 0.980 | 0.990 | 1.02 | V/V |
|  |  | Full | 0.975 | - | 1.025 | V/V |
| Gain | $A_{V}=+2, \mathrm{~V}_{\mathrm{IN}}=+1 \mathrm{~V}$ | 25 | 1.96 | 1.98 | 2.04 | V/V |
|  |  | Full | 1.95 | - | 2.05 | V/V |
| DC Non-Linearity (Note 3) | $\mathrm{A}_{\mathrm{V}}=+2, \pm 2 \mathrm{~V}$ Full Scale | 25 | - | 0.02 | - | \% |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| Output Voltage (Note 3) | $A_{V}=-1$ | 25 | $\pm 3.0$ | $\pm 3.3$ | - | V |
|  |  | Full | $\pm 2.5$ | $\pm 3.0$ | - | V |
| Output Current (Note 3) | $\mathrm{R}_{\mathrm{L}}=50 \Omega$ | 25, 85 | 50 | 60 | - | mA |
|  |  | -40 | 35 | 50 | - | mA |
| Closed Loop Output Impedance | $D C, A_{V}=+2$ | 25 | - | 0.3 | - | $\Omega$ |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Supply Voltage Range |  | Full | $\pm 4.5$ | - | $\pm 5.5$ | V |
| Supply Current (Note 3) |  | 25 | - | 21 | 26 | mA |
|  |  | Full | - | - | 33 | mA |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| -3dB Bandwidth $\left(\mathrm{V}_{\text {OUT }}=0.2 \mathrm{~V}_{\text {P-P }}\right.$, Notes 2, 3) | $A_{V}=-1$ | 25 | 450 | 800 | - | MHz |
|  | $A_{V}=+1$ | 25 | 500 | 850 | - | MHz |
|  | $A_{V}=+2$ | 25 | 350 | 550 | - | MHz |

HFA1112
Electrical Specifications $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, A_{V}=+1, R_{L}=100 \Omega$, Unless Otherwise Specified (Continued)

| PARAMETER | TEST CONDITIONS | TEMP ( ${ }^{\circ} \mathrm{C}$ ) | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Slew Rate ( $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$, Note 2) | $A_{V}=-1$ | 25 | 1500 | 2400 | - | V/us |
|  | $\mathrm{A}_{\mathrm{V}}=+1$ | 25 | 800 | 1500 | - | V/us |
|  | $A_{V}=+2$ | 25 | 1100 | 1900 | - | V/us |
| Full Power Bandwidth ( $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$, Note 3) | $A_{V}=-1$ | 25 | - | 300 | - | MHz |
|  | $\mathrm{A}_{\mathrm{V}}=+1$ | 25 | - | 150 | - | MHz |
|  | $A_{V}=+2$ | 25 | - | 220 | - | MHz |
| Gain Flatness (to 30MHz, Notes 2, 3) | $A_{V}=-1$ | 25 | - | $\pm 0.02$ | - | dB |
|  | $A_{V}=+1$ | 25 | - | $\pm 0.1$ | - | dB |
|  | $A_{V}=+2$ | 25 | - | $\pm 0.015$ | $\pm 0.04$ | dB |
| Gain Flatness (to 50MHz, Notes 2, 3) | $A_{V}=-1$ | 25 | - | $\pm 0.05$ | - | dB |
|  | $A_{V}=+1$ | 25 | - | $\pm 0.2$ | - | dB |
|  | $A_{V}=+2$ | 25 | - | $\pm 0.036$ | $\pm 0.08$ | dB |
| Gain Flatness (to 100 MHz , Notes 2, 3) | $A_{V}=-1$ | 25 | - | $\pm 0.10$ | - | dB |
|  | $A_{V}=+2$ | 25 | - | $\pm 0.07$ | $\pm 0.22$ | dB |
| Linear Phase Deviation (to 100MHz, Note 3) | $A_{V}=-1$ | 25 | - | $\pm 0.13$ | - | Degrees |
|  | $A_{V}=+1$ | 25 | - | $\pm 0.83$ | - | Degrees |
|  | $A_{V}=+2$ | 25 | - | $\pm 0.05$ | - | Degrees |
| 2nd Harmonic Distortion $\left(30 \mathrm{MHz}, \mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-p }}\right.$, Notes 2, 3) | $A_{V}=-1$ | 25 | - | -52 | - | dBc |
|  | $\mathrm{A}_{\mathrm{V}}=+1$ | 25 | - | -57 | - | dBc |
|  | $A_{V}=+2$ | 25 | - | -52 | -45 | dBc |
| 3rd Harmonic Distortion $\left(30 \mathrm{MHz}, \mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}\right.$, Notes 2, 3) | $A_{V}=-1$ | 25 | - | -71 | - | dBc |
|  | $A_{V}=+1$ | 25 | - | -73 | - | dBc |
|  | $A_{V}=+2$ | 25 | - | -72 | -65 | dBc |
| 2nd Harmonic Distortion <br> $\left(50 \mathrm{MHz}, \mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-p }}\right.$, Notes 2,3$)$ | $A_{V}=-1$ | 25 | - | -47 | - | dBc |
|  | $A_{V}=+1$ | 25 | - | -53 | - | dBc |
|  | $A_{V}=+2$ | 25 | - | -47 | -40 | dBc |
| 3rd Harmonic Distortion $\left(50 \mathrm{MHz}, \mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-p }}\right.$, Notes 2,3$)$ | $A_{V}=-1$ | 25 | - | -63 | - | dBc |
|  | $\mathrm{A}_{\mathrm{V}}=+1$ | 25 | - | -68 | - | dBc |
|  | $\mathrm{A}_{\mathrm{V}}=+2$ | 25 | - | -65 | -55 | dBc |
| 2nd Harmonic Distortion <br> (100MHz, $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$, Notes 2, 3) | $A_{V}=-1$ | 25 | - | -41 | - | dBc |
|  | $\mathrm{A}_{\mathrm{V}}=+1$ | 25 | - | -50 | - | dBc |
|  | $A_{V}=+2$ | 25 | - | -42 | -35 | dBc |
| 3rd Harmonic Distortion (100MHz, $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$, Notes 2, 3) | $A_{V}=-1$ | 25 | - | -55 | - | dBc |
|  | $\mathrm{A}_{\mathrm{V}}=+1$ | 25 | - | -49 | - | dBc |
|  | $\mathrm{A}_{\mathrm{V}}=+2$ | 25 | - | -62 | -45 | dBc |
| 3rd Order Intercept ( $\mathrm{A}_{\mathrm{V}}=+2$, Note 3) | 100MHz | 25 | - | 28 | - | dBm |
|  | 300 MHz | 25 | - | 13 | - | dBm |
| 1dB Compression ( $\mathrm{A}_{\mathrm{V}}=+2$, Note 3) | 100MHz | 25 | - | 19 | - | dBm |
|  | 300 MHz | 25 | - | 12 | - | dBm |
| Reverse Isolation ( $\mathrm{S}_{12}$, Note 3) | 40 MHz | 25 | - | -70 | - | dB |
|  | 100MHz | 25 | - | -60 | - | dB |
|  | 600MHz | 25 | - | -32 | - | dB |
| TRANSIENT CHARACTERISTICS |  |  |  |  |  |  |
| $\begin{aligned} & \text { Rise Time } \\ & \left(\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}\right. \text { Step, Note 2) } \end{aligned}$ | $A_{V}=-1$ | 25 | - | 500 | 800 | ps |
|  | $A_{V}=+1$ | 25 | - | 480 | 750 | ps |
|  | $A_{V}=+2$ | 25 | - | 700 | 1000 | ps |

Electrical Specifications $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=+1, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified (Continued)

| PARAMETER | TEST CONDITIONS | TEMP ( ${ }^{\circ} \mathrm{C}$ ) | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Rise Time } \\ & \left(\mathrm{V}_{\text {OUT }}=2 \mathrm{~V} \text { Step }\right) \end{aligned}$ | $\mathrm{A}_{\mathrm{V}}=-1$ | 25 | - | 0.82 | - | ns |
|  | $A_{V}=+1$ | 25 | - | 1.06 | - | ns |
|  | $A_{V}=+2$ | 25 | - | 1.00 | - | ns |
| Overshoot <br> $\left(\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}\right.$ Step, Input $\mathrm{t}_{\mathrm{R}} / \mathrm{t}_{\mathrm{F}}=200 \mathrm{ps}$, <br> Notes 2, 3, 4) | $A_{V}=-1$ | 25 | - | 12 | 30 | \% |
|  | $A_{V}=+1$ | 25 | - | 45 | 65 | \% |
|  | $\mathrm{A}_{V}=+2$ | 25 | - | 6 | 20 | \% |
| 0.1\% Settling Time (Note 3) | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ to 0 V | 25 | - | 11 | - | ns |
| 0.05\% Settling Time | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ to 0 V | 25 | - | 15 | - | ns |
| Overdrive Recovery Time | $\mathrm{V}_{\text {IN }}=5 \mathrm{~V}_{\text {P-P }}$ | 25 | - | 8.5 | - | ns |
| Differential Gain | $A_{V}=+1,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.03 | - | \% |
|  | $A_{V}=+2,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.02 | - | \% |
| Differential Phase | $A_{V}=+1,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.05 | - | Degrees |
|  | $A_{V}=+2,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.04 | - | Degrees |

NOTES:
2. This parameter is not tested. The limits are guaranteed based on lab characterization, and reflect lot-to-lot variation.
3. See Typical Performance Curves for more information.
4. Overshoot decreases as input transition times increase, especially for $A_{V}=+1$. Please refer to Typical Performance Curves.

## Application Information

## Closed Loop Gain Selection

The HFA1112 features a novel design which allows the user to select from three closed loop gains, without any external components. The result is a more flexible product, fewer part types in inventory, and more efficient use of board space.

This "buffer" operates in closed loop gains of $-1,+1$, or +2 , and gain selection is accomplished via connections to the $\pm$ inputs. Applying the input signal to +IN and floating -IN selects a gain of +1 , while grounding $-\mathbb{N}$ selects a gain of +2 . A gain of -1 is obtained by applying the input signal to -IN with +IN grounded.

The table below summarizes these connections:

| GAIN <br> (ACL) | CONNECTIONS |  |
| :---: | :---: | :---: |
|  | +INPUT (PIN 3) | -INPUT (PIN 2) |
| -1 | GND | Input |
| +1 | Input | NC (Floating) |
| +2 | Input | GND |

## PC Board Layout

The frequency response of this amplifier depends greatly on the amount of care taken in designing the PC board. The use of low inductance components such as chip resistors and chip capacitors is strongly recommended, while a solid ground plane is a must!
Attention should be given to decoupling the power supplies. A large value $(10 \mu \mathrm{~F})$ tantalum in parallel with a small value $(0.1 \mu \mathrm{~F})$ chip capacitor works well in most cases.

Terminated microstrip signal lines are recommended at the input and output of the device. Capacitance directly on the output must be minimized, or isolated as discussed in the next section.

For unity gain applications, care must also be taken to minimize the capacitance to ground seen by the amplifier's inverting input. At higher frequencies this capacitance will tend to short the -INPUT to GND, resulting in a closed loop gain which increases with frequency. This will cause excessive high frequency peaking and potentially other problems as well.

An example of a good high frequency layout is the Evaluation Board shown in Figure 2.

## Driving Capacitive Loads

Capacitive loads, such as an A/D input, or an improperly terminated transmission line will degrade the amplifier's phase margin resulting in frequency response peaking and possible oscillations. In most cases, the oscillation can be avoided by placing a resistor $\left(R_{S}\right)$ in series with the output prior to the capacitance.

Figure 1 details starting points for the selection of this resistor. The points on the curve indicate the $\mathrm{R}_{\mathrm{S}}$ and $\mathrm{C}_{\mathrm{L}}$ combinations for the optimum bandwidth, stability, and settling time, but experimental fine tuning is recommended. Picking a point above or to the right of the curve yields an overdamped response, while points below or left of the curve indicate areas of underdamped performance.
$R_{S}$ and $C_{L}$ form a low pass network at the output, thus limiting system bandwidth well below the amplifier bandwidth of 850 MHz . By decreasing $R_{S}$ as $C_{L}$ increases (as illustrated in the curves), the maximum bandwidth is
obtained without sacrificing stability. Even so, bandwidth does decrease as you move to the right along the curve. For example, at $A_{V}=+1, R_{S}=50 \Omega, C_{L}=30 \mathrm{pF}$, the overall bandwidth is limited to 300 MHz , and bandwidth drops to 100 MHz at $A_{V}=+1, R_{S}=5 \Omega, C_{L}=340 \mathrm{pF}$.


FIGURE 1. RECOMMENDED SERIES OUTPUT RESISTOR vs LOAD CAPACITANCE

## Evaluation Board

The performance of the HFA1112 may be evaluated using the HFA11XX Evaluation Board, slightly modified as follows:

1. Remove the $500 \Omega$ feedback resistor $\left(R_{2}\right)$, and leave the connection open.
2. a. For $A_{V}=+1$ evaluation, remove the $500 \Omega$ gain setting resistor ( $\mathrm{R}_{1}$ ), and leave pin 2 floating.
b. For $A_{V}=+2$, replace the $500 \Omega$ gain setting resistor with a $0 \Omega$ resistor to GND.

The layout and modified schematic of the board are shown in Figure 2.

To order evaluation boards (part number HFA11XXEVAL), please contact your local sales office.


FIGURE 2. EVALUATION BOARD SCHEMATIC AND LAYOUT

Typical Performance Curves $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified


FIGURE 3. SMALL SIGNAL PULSE RESPONSE


FIGURE 5. SMALL SIGNAL PULSE RESPONSE


FIGURE 7. SMALL SIGNAL PULSE RESPONSE


FIGURE 4. LARGE SIGNAL PULSE RESPONSE


FIGURE 6. LARGE SIGNAL PULSE RESPONSE


FIGURE 8. LARGE SIGNAL PULSE RESPONSE

Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified (Continued)


FIGURE 9. FREQUENCY RESPONSE


FIGURE 11. FREQUENCY RESPONSE FOR VARIOUS LOAD RESISTORS


FIGURE 13. FREQUENCY RESPONSE FOR VARIOUS OUTPUT VOLTAGES


FIGURE 10. FREQUENCY RESPONSE FOR VARIOUS LOAD RESISTORS


FIGURE 12. FREQUENCY RESPONSE FOR VARIOUS LOAD RESISTORS


FIGURE 14. FREQUENCY RESPONSE FOR VARIOUS OUTPUT VOLTAGES

Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified (Continued)


FIGURE 15. FREQUENCY RESPONSE FOR VARIOUS OUTPUT VOLTAGES


FIGURE 17. -3dB BANDWIDTH vs TEMPERATURE


FIGURE 19. DEVIATION FROM LINEAR PHASE


FIGURE 16. FULL POWER BANDWIDTH


FIGURE 18. GAIN FLATNESS


FIGURE 20. SETTLING RESPONSE

## Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified (Continued)



FIGURE 21. LOW FREQUENCY REVERSE ISOLATION ( $\mathrm{S}_{12}$ )


FIGURE 23. 1dB GAIN COMPRESSION vs FREQUENCY


FIGURE 25. 2nd HARMONIC DISTORTION vs Pout


FIGURE 22. HIGH FREQUENCY REVERSE ISOLATION ( $\mathrm{S}_{12}$ )


FIGURE 24. 3rd ORDER INTERMODULATION INTERCEPT vs FREQUENCY


FIGURE 26. 3rd HARMONIC DISTORTION vs Pout

## Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified (Continued)



FIGURE 27. 2nd HARMONIC DISTORTION vs POUT


FIGURE 29. 2nd HARMONIC DISTORTION vs Pout


FIGURE 31. INTEGRAL LINEARITY ERROR


FIGURE 28. 3rd HARMONIC DISTORTION vs POUT


FIGURE 30. 3rd HARMONIC DISTORTION vs POUT


FIGURE 32. OVERSHOOT vs INPUT RISE TIME

## Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified (Continued)



FIGURE 33. OVERSHOOT vs INPUT RISE TIME


FIGURE 35. SUPPLY CURRENT vs SUPPLY VOLTAGE


FIGURE 37. OUTPUT VOLTAGE vs TEMPERATURE


FIGURE 34. OVERSHOOT vs INPUT RISE TIME


FIGURE 36. SUPPLY CURRENT vs TEMPERATURE


FIGURE 38. INPUT NOISE CHARACTERISTICS

## Die Characteristics

DIE DIMENSIONS
63 mils $\times 44$ mils $\times 19$ mils
$1600 \mu \mathrm{~m} \times 1130 \mu \mathrm{~m} 483 \mu \mathrm{~m}$

## METALLIZATION

Type: Metal 1: AICu (2\%)/TiW
Thickness: Metal 1: $8 \mathrm{k} \AA \pm 0.4 \mathrm{k} \AA$
Type: Metal 2: AICu (2\%)
Thickness: Metal 2: $16 \mathrm{k} \AA \pm 0.8 \mathrm{k} \AA$

## PASSIVATION

Type: Nitride
Thickness: $4 \mathrm{k} \AA \pm 0.5 \mathrm{k} \AA$
TRANSISTOR COUNT
52
SUBSTRATE POTENTIAL (POWERED UP)
Floating (Recommend Connection to V-)

Metallization Mask Layouts


OUT

## Dual-In-Line Plastic Packages (PDIP)


$-\mathrm{B}-\mathrm{s}$


NOTES:

1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
4. Dimensions $A, A 1$ and $L$ are measured with the package seated in JEDEC seating plane gauge GS-3.
5. D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
6. $E$ and $\mathrm{e}_{\mathrm{A}}$ are measured with the leads constrained to be perpendicular to datum -C -
7. $e_{B}$ and $e_{C}$ are measured at the lead tips with the leads unconstrained. $e_{C}$ must be zero or greater.
8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch ( 0.25 mm ).
9. N is the maximum number of terminal positions.
10. Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of $0.030-0.045$ inch (0.76-1.14mm).

## E8.3 (JEDEC MS-001-BA ISSUE D)

 8 LEAD DUAL-IN-LINE PLASTIC PACKAGE| SYMBOL | INCHES |  | MILLIMETERS |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |  |  |  |  |  |  |
| A | - | 0.210 | - | 5.33 | 4 |  |  |  |  |  |  |
| A1 | 0.015 | - | 0.39 | - | 4 |  |  |  |  |  |  |
| A2 | 0.115 | 0.195 | 2.93 | 4.95 | - |  |  |  |  |  |  |
| B | 0.014 | 0.022 | 0.356 | 0.558 | - |  |  |  |  |  |  |
| B1 | 0.045 | 0.070 | 1.15 | 1.77 | 8,10 |  |  |  |  |  |  |
| C | 0.008 | 0.014 | 0.204 | 0.355 | - |  |  |  |  |  |  |
| D | 0.355 | 0.400 | 9.01 | 10.16 | 5 |  |  |  |  |  |  |
| D1 | 0.005 | - | 0.13 | - | 5 |  |  |  |  |  |  |
| E | 0.300 | 0.325 | 7.62 | 8.25 | 6 |  |  |  |  |  |  |
| E1 | 0.240 | 0.280 | 6.10 | 7.11 | 5 |  |  |  |  |  |  |
| e | 0.100 | BSC | 2.54 | BSC | - |  |  |  |  |  |  |
| $e_{A}$ | 0.300 | BSC | 7.62 | BSC | 6 |  |  |  |  |  |  |
| $e_{B}$ | - | 0.430 | - | 10.92 | 7 |  |  |  |  |  |  |
| L | 0.115 | 0.150 | 2.93 | 3.81 | 4 |  |  |  |  |  |  |
| N | 8 |  |  |  |  |  |  | 8 |  |  | 9 |

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## Small Outline Plastic Packages (SOIC)



NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed $0.15 \mathrm{~mm}(0.006$ inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25 mm ( 0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. " L " is the length of terminal for soldering to a substrate.
7. " N " is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width "B", as measured 0.36 mm ( 0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61 mm ( 0.024 inch).
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

M8.15 (JEDEC MS-012-AA ISSUE C) 8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL | INCHES |  | MILLIMETERS |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |  |  |  |  |  |
| A | 0.0532 | 0.0688 | 1.35 | 1.75 | - |  |  |  |  |  |
| A1 | 0.0040 | 0.0098 | 0.10 | 0.25 | - |  |  |  |  |  |
| B | 0.013 | 0.020 | 0.33 | 0.51 | 9 |  |  |  |  |  |
| C | 0.0075 | 0.0098 | 0.19 | 0.25 | - |  |  |  |  |  |
| D | 0.1890 | 0.1968 | 4.80 | 5.00 | 3 |  |  |  |  |  |
| E | 0.1497 | 0.1574 | 3.80 | 4.00 | 4 |  |  |  |  |  |
| e | 0.050 | BSC | 1.27 |  | BSC |  |  |  |  |  |
| H | 0.2284 | 0.2440 | 5.80 | 6.20 | - |  |  |  |  |  |
| h | 0.0099 | 0.0196 | 0.25 | 0.50 | 5 |  |  |  |  |  |
| L | 0.016 | 0.050 | 0.40 | 1.27 | 6 |  |  |  |  |  |
| N | 8 |  |  |  |  |  |  |  | 8 | 7 |
| $\alpha$ | $0^{\circ}$ | $8^{\circ}$ | $00^{\circ}$ | $8^{\circ}$ | - |  |  |  |  |  |

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